

**Addendum**

HC908JL8AD/D  
Rev. 0, 5/2002

Addendum to  
MC68HC908JL8  
Technical Data



This addendum provides update and additional information to the  
*MC68HC908JL8 Technical Data, Rev. 2*  
(Motorola document number MC68HC908JL8/D)

**MC68HC08JL8  
MC68HC08JK8**

The MC68HC08JL8 is the ROM part equivalent to the MC68HC908JL8. The entire MC68HC908JL8 data book apply to this ROM device, with exceptions outlined in this addendum.

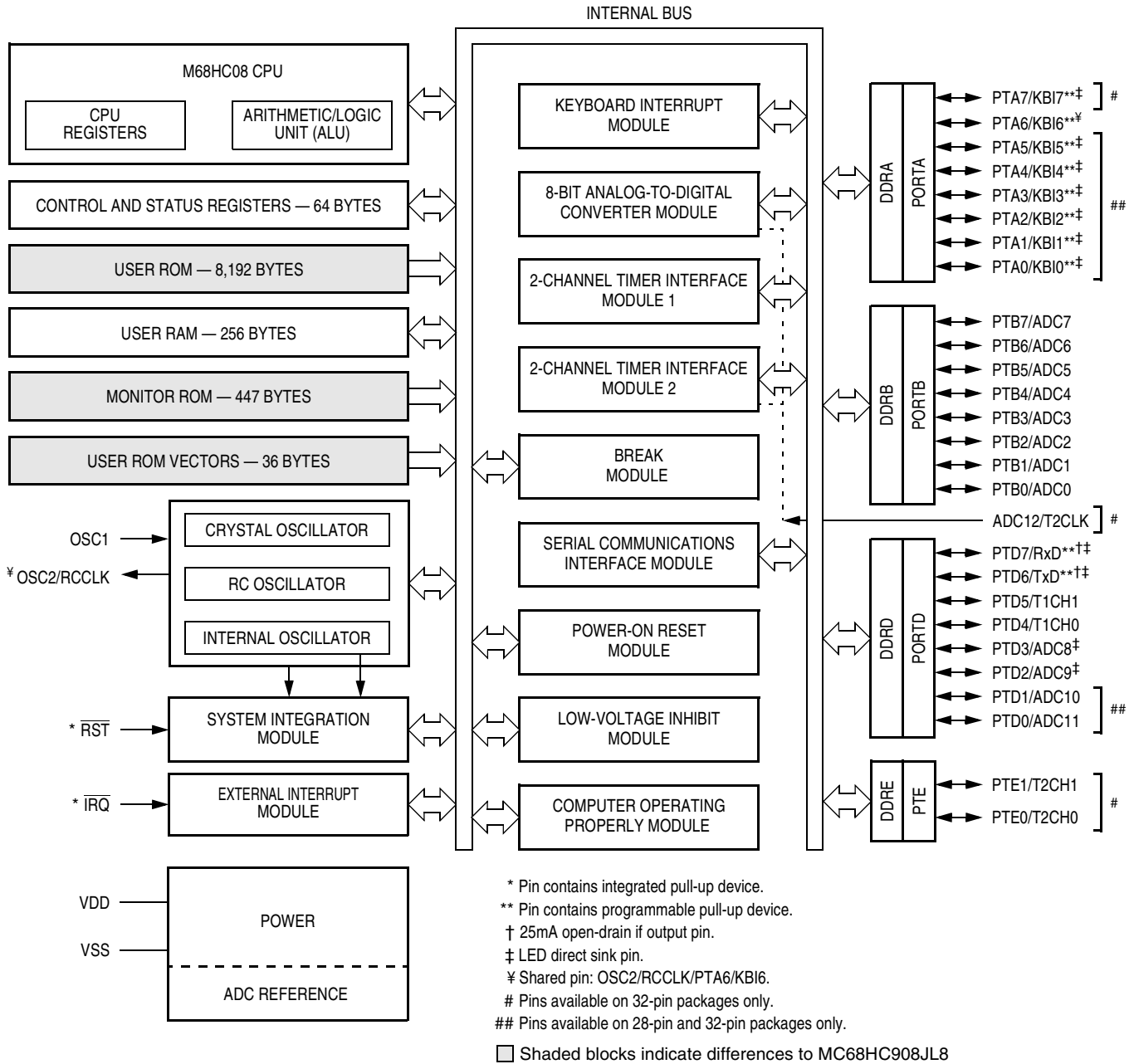
**Table 1. Summary of MC68HC08JL8 and MC68HC908JL8 Differences**

	<b>MC68HC08JL8</b>	<b>MC68HC908JL8</b>
<b>Memory (\$DC00–\$FBFF)</b>	8,192 bytes ROM	8,192 bytes FLASH
<b>User vectors (\$FFDC–\$FFFF)</b>	36 bytes ROM	36 bytes FLASH
<b>Registers at \$FE08 and \$FFCF</b>	Not used; locations are reserved.	FLASH related registers. \$FE08 — FLCR \$FFCF — FLBPR
<b>Mask option register (\$FFD0)</b>	Defined by mask; read only.	Read/write FLASH register.
<b>Monitor ROM (\$FC00–\$FDFF and \$FE10–\$FFCE)</b>	\$FC00–\$FDFF: Not used. \$FE10–\$FFCE: Used for testing purposes only.	Used for testing and FLASH programming/erasing.
<b>Available Packages</b>	20-pin PDIP (MC68HC08JK8) 20-pin SOIC (MC68HC08JK8) 28-pin PDIP 28-pin SOIC 32-pin SDIP 32-pin LQFP	20-pin PDIP (MC68HC908JK8) 20-pin SOIC (MC68HC908JK8) 28-pin PDIP 28-pin SOIC 32-pin SDIP 32-pin LQFP

**MCU Block Diagram** Figure 1 shows the block diagram of the MC68HC08JL8.

**Memory Map** The MC68HC08JL8 has 8,192 bytes of user ROM from \$DC00 to \$FBFF, and 36 bytes of user ROM vectors from \$FFDC to \$FFFF. On the MC68HC908JL8, these memory locations are FLASH memory.

Figure 2 shows the memory map of the MC68HC08JL8.



**Figure 1. MC68HC08JL8 Block Diagram**

\$0000 ↓ \$003F	I/O REGISTERS 64 BYTES
\$0040 ↓ \$005F	RESERVED 32 BYTES
\$0060 ↓ \$015F	RAM 256 BYTES
\$0160 ↓ \$DBFF	UNIMPLEMENTED 55,968 BYTES
\$DC00 ↓ \$FBFF	ROM 8,192 BYTES
\$FC00 ↓ \$FDFF	UNIMPLEMENTED 512 BYTES
\$FE00	BREAK STATUS REGISTER (BSR)
\$FE01	RESET STATUS REGISTER (RSR)
\$FE02	RESERVED
\$FE03	BREAK FLAG CONTROL REGISTER (BFCR)
\$FE04	INTERRUPT STATUS REGISTER 1 (INT1)
\$FE05	INTERRUPT STATUS REGISTER 2 (INT2)
\$FE06	INTERRUPT STATUS REGISTER 3 (INT3)
\$FE07	RESERVED
\$FE08	RESERVED
\$FE09 ↓ \$FF0B	RESERVED
\$FE0C	BREAK ADDRESS HIGH REGISTER (BRKH)
\$FE0D	BREAK ADDRESS LOW REGISTER (BRKL)
\$FE0E	BREAK STATUS AND CONTROL REGISTER (BRKSCR)
\$FE0F	RESERVED
\$FE10 ↓ \$FFCE	MONITOR ROM 447 BYTES
\$FFCF	RESERVED
\$FFD0	MASK OPTION REGISTER (MOR) — READ ONLY
\$FFD1 ↓ \$FFDB	RESERVED 11 BYTES
\$FFDC ↓ \$FFFF	USER ROM VECTORS 36 BYTES

**Figure 2. MC68HC08JL8 Memory Map**

- Reserved Registers**      The two registers at \$FE08 and \$FFCF are reserved locations on the MC68HC08JL8.
- On the MC68HC908JL8, these two locations are the FLASH control register and the FLASH block protect register respectively.
- Mask Option Register**      The mask option register at \$FFD0 is read only. The value is defined by mask option (hard-wired connections) specified at the time as the ROM code submission.
- On the MC68HC908JL8, the MOR is implemented as a FLASH, which can be programmed, erased, and read.
- Monitor ROM**      The monitor program (monitor ROM: \$FE10–\$FFCE) on the MC68HC08JL8 is for device testing only. \$FC00–\$FDFF are unused.
- Electrical Specifications**      Electrical specifications for the MC68HC908JL8 apply to the MC68HC08JL8, except for the parameters indicated below.

*DC Electrical Characteristics*

**Table 2. DC Electrical Characteristics (5V)**

Characteristic <sup>(1)</sup>	Symbol	Min	Typ <sup>(2)</sup>	Max	Unit
V <sub>DD</sub> supply current, f <sub>OP</sub> = 8MHz RC oscillator option	I <sub>DD</sub>	Values same as, and characterized from MC68HC908JL8, but not tested.			
Low-voltage inhibit, trip falling voltage	V <sub>TRIPF</sub>	3.55 (3.60) <sup>(3)</sup>	4.02 (4.25)	4.48 (4.48)	V
Low-voltage inhibit, trip rising voltage	V <sub>TRIPR</sub>	3.66 (3.75)	4.13 (4.40)	4.59 (4.63)	V

1. V<sub>DD</sub> = 4.5 to 5.5 Vdc, V<sub>SS</sub> = 0 Vdc, T<sub>A</sub> = T<sub>L</sub> to T<sub>H</sub>, unless otherwise noted.
2. Typical values reflect average measurements at midpoint of voltage range, 25 °C only.
3. The numbers in parenthesis are MC68HC908JL8 values.

**Table 3. DC Electrical Characteristics (3V)**

Characteristic <sup>(1)</sup>	Symbol	Min	Typ <sup>(2)</sup>	Max	Unit
V <sub>DD</sub> supply current, f <sub>OP</sub> = 4MHz RC oscillator option	I <sub>DD</sub>	Values same as, and characterized from MC68HC908JL8, but not tested.			
Low-voltage inhibit, trip voltage (No hysteresis implemented for 3V LVI)	V <sub>LVI3</sub>	2.1 (2.18) <sup>(3)</sup>	2.4 (2.49)	2.69 (2.68)	V

1. V<sub>DD</sub> = 2.7 to 3.3 Vdc, V<sub>SS</sub> = 0 Vdc, T<sub>A</sub> = T<sub>L</sub> to T<sub>H</sub>, unless otherwise noted.
2. Typical values reflect average measurements at midpoint of voltage range, 25 °C only.
3. The numbers in parenthesis are MC68HC908JL8 values.

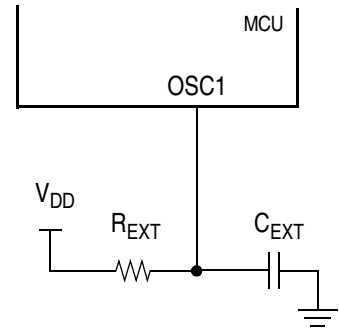
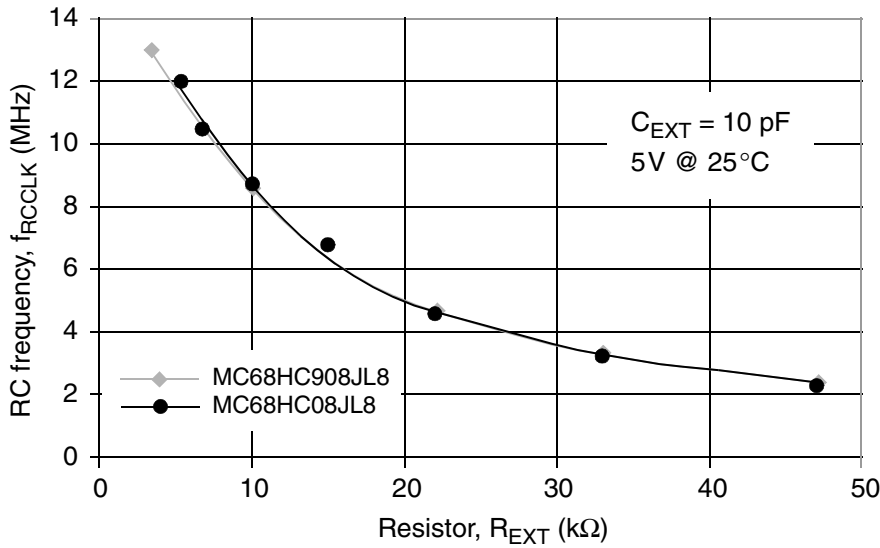


Figure 3. RC vs. Frequency (5V @ 25°C)

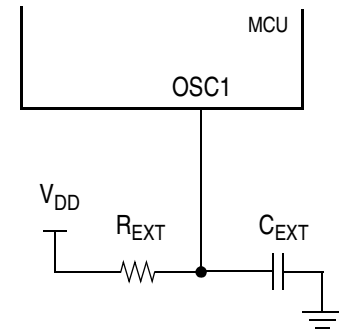
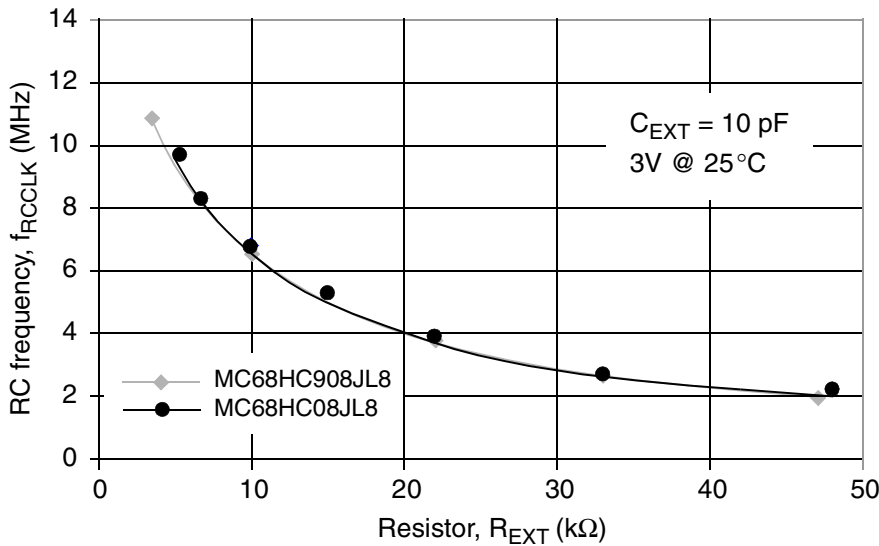


Figure 4. RC vs. Frequency (3V @ 25°C)

Memory Characteristics

Table 4. Memory Characteristics

Characteristic	Symbol	Min	Max	Unit
RAM data retention voltage	$V_{RDR}$	1.3	—	V

Notes:

Since MC68HC08JL8 is a ROM device, FLASH memory electrical characteristics do not apply.

**MC68HC08JL8  
Order Numbers**

These part numbers are generic numbers only. To place an order, ROM code must be submitted to the ROM Processing Center (RPC).

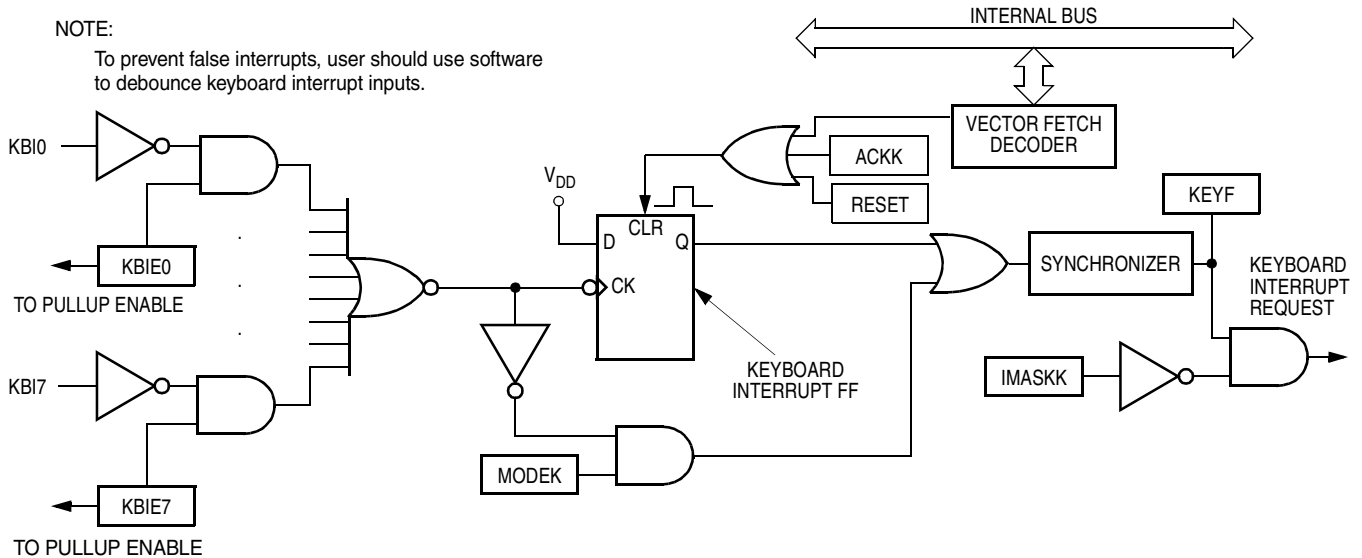
**Table 5. MC68HC08JL8 Order Numbers**

MC Order Number	Operating Temperature Range	Package
MC68HC08JK8CP	-40 °C to +85 °C	20-pin PDIP
MC68HC08JK8MP	-40 °C to +125 °C	
MC68HC08JK8CDW	-40 °C to +85 °C	20-pin SOIC
MC68HC08JK8MDW	-40 °C to +125 °C	
MC68HC08JL8CP	-40 °C to +85 °C	28-pin PDIP
MC68HC08JL8MP	-40 °C to +125 °C	
MC68HC08JL8CDW	-40 °C to +85 °C	28-pin SOIC
MC68HC08JL8MDW	-40 °C to +125 °C	
MC68HC08JL8CSP	-40 °C to +85 °C	32-pin SDIP
MC68HC08JL8MSP	-40 °C to +125 °C	
MC68HC08JL8CFA	-40 °C to +85 °C	32-pin LQFP
MC68HC08JL8MFA	-40 °C to +125 °C	

NOTE: Temperature grade "M" is available for  $V_{DD} = 5V$  only.

AMENDMENTS TO MC68HC908JL8/D, REV. 2

**Keyboard Interrupt** Page 243, **Figure 15-2. Keyboard Interrupt Block Diagram** — Replace with the following block diagram:



**Computer Operating Properly (COP)** Page 254, **16.8.2 Stop Mode** — Replace the two paragraphs:

*From:* Stop mode turns off the ICLK input to the COP if the STOP\_ICLKDIS bit is set in configuration register 2 (CONFIG2). Service the COP immediately before entering or after exiting stop mode to ensure a full COP timeout period after entering or exiting stop mode.

After reset, the STOP\_ICLKDIS bit is clear by default and ICLK is enabled during stop mode.

*To:* Stop mode turns off the ICLK input to the COP and clears the COP prescaler. Service the COP immediately before entering or after exiting stop mode to ensure a full COP timeout period after entering or exiting stop mode.

To prevent inadvertently turning off the COP with a STOP instruction, a configuration option is available that disables the STOP instruction. When the STOP bit in the configuration register has the STOP instruction is disabled, execution of a STOP instruction results in an illegal opcode reset.

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